

## SI6426DQ-T1-GE3-VB Datasheet N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
30	0.012 at V <sub>GS</sub> = 10 V	8.5	7.1			
30	0.014 at V <sub>GS</sub> = 4.5 V	7.6	7.1			

#### **FEATURES**

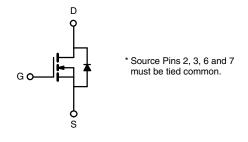
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



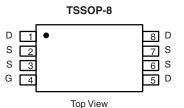
ROHS COMPLIANT

#### **APPLICATIONS**

- Notebook System Power
- Low Current DC/DC







ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	$V_{DS}$	30	V			
Gate-Source Voltage	$V_{GS}$	± 20	]			
	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	8.5			
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		7.5			
Continuous Brain Current (1) = 100 °C)	T <sub>A</sub> = 25 °C		7.2 <sup>b, c</sup>			
	T <sub>A</sub> = 70 °C		5.9 <sup>b, c</sup>			
Pulsed Drain Current		I <sub>DM</sub>	30	Α		
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	2.8			
Source-Drain Guitent Blode Guitent	T <sub>A</sub> = 25 °C		1.8 <sup>b, c</sup>			
Pulsed Source-Drain Current	I <sub>SM</sub>	30				
Single Pulse Avalanche Current  L = 0.1 n		I <sub>AS</sub>	10			
Single Pulse Avalanche Energy	L = 0.1 IIII1	E <sub>AS</sub>	5			
	T <sub>C</sub> = 25 °C	P <sub>D</sub>	3.1	W		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		2.0			
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C		2.0 <sup>b, c</sup>			
	T <sub>A</sub> = 70 °C		1.25 <sup>b, c</sup>			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	52	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady-State	$R_{thJF}$	30	40	0, ,,	

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 110 °C/W.

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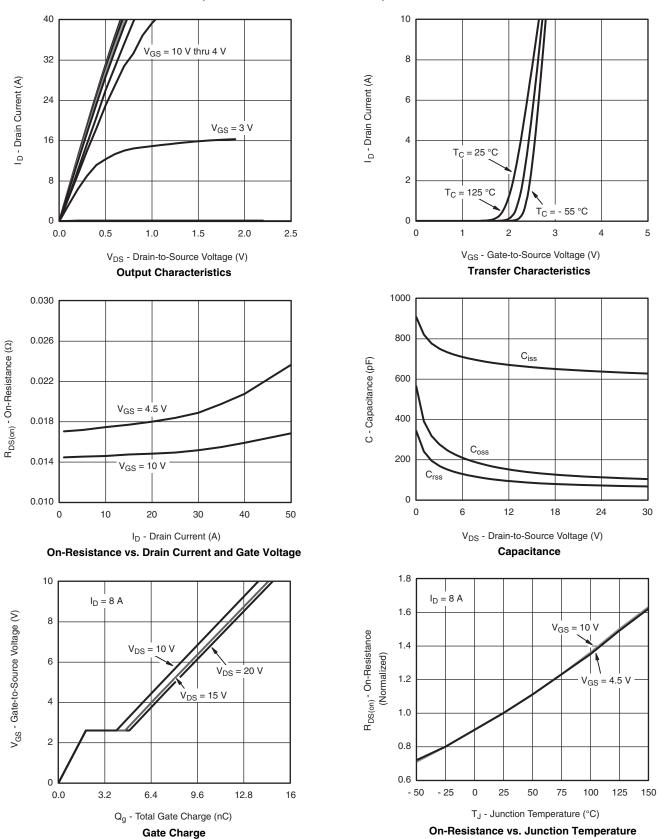


Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		3.0		\//0C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.2		mV/°C
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2		2.5	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA
Zara Cata Valtaga Drain Current	1	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1	μА
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, TJ = 55 ^{\circ}\text{C}$			10	
On -State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	20			Α
5	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		0.012		Ω
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.014		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 8 A		27		S
Dynamic <sup>a</sup>						
Input Capacitance	C <sub>iss</sub>			660		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 MHz		140		
Reverse Transfer Capacitance	C <sub>rss</sub>			86		1
T	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$		14.5	22	
Total Gate Charge	Q <sub>g</sub>			7.1	11	,,,
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 8 \text{ A}$		1.9		nC
Gate-Drain Charge	$Q_{gd}$			2.7		
Gate Resistance	$R_g$	f = 1 MHz	0.5	2.6	5.2	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			14	28	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		45	80	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		18	35	
Fall Time	t <sub>f</sub>			12	24	ne
Turn-On Delay Time	t <sub>d(on)</sub>			7	14	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		15	30	
Fall Time	t <sub>f</sub>			7	14	
<b>Drain-Source Body Diode Characterist</b>	ics					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			2.8	Α
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				30	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 2 A		0.77	1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			17	34	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		9	18	nC
Reverse Recovery Fall Time	t <sub>a</sub>	1 3 Λ, αι/αι		10		nS
Reverse Recovery Rise Time	t <sub>b</sub>			7		110

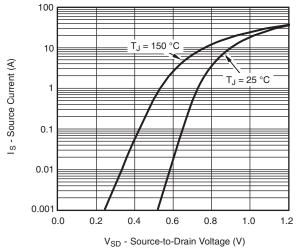
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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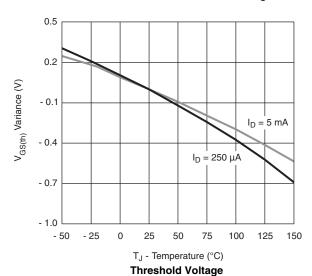


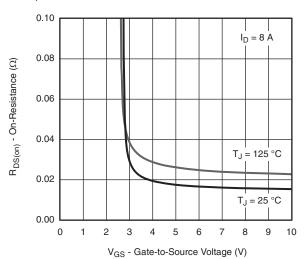




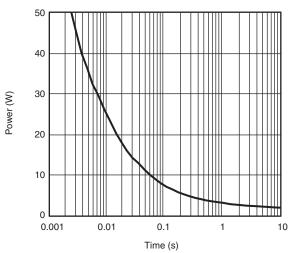


#### Source-Drain Diode Forward Voltage

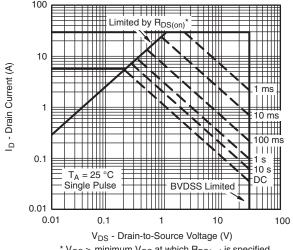




On-Resistance vs. Gate-to-Source Voltage



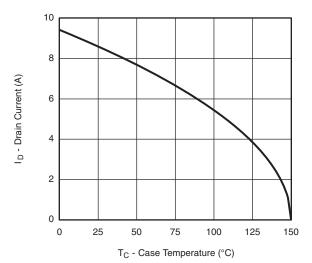
Single Pulse Power, Junction-to-Ambient



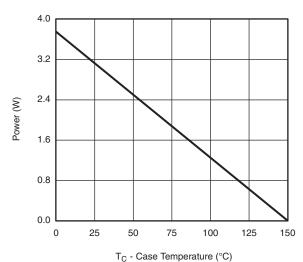
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

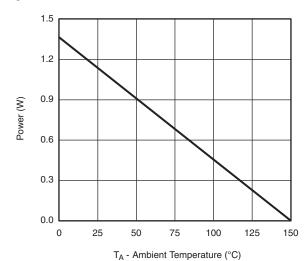
Safe Operating Area, Junction-to-Ambient





#### Current Derating\*



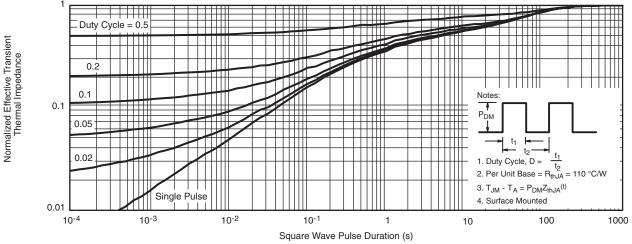


Power Derating, Junction-to-Foot

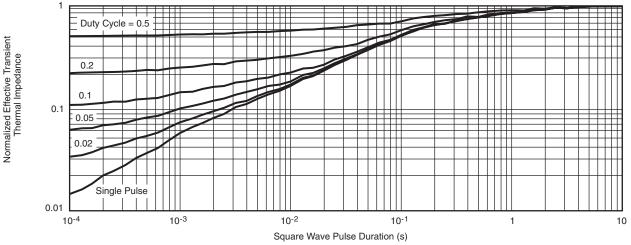
Power Derating, Junction-to-Ambient

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

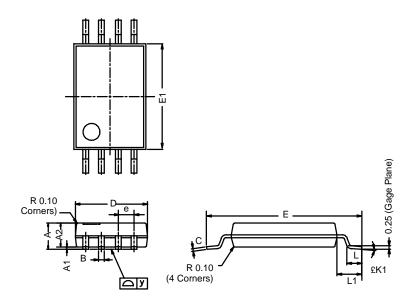


Normalized Thermal Transient Impedance, Junction-to-Foot



TSSOP: 8-LEAD

**JEDEC Part Number: MO-153** 

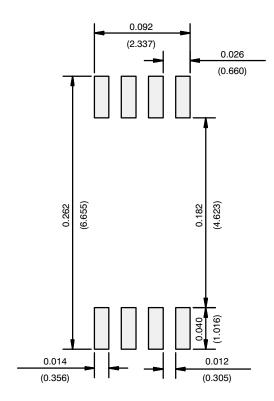


	MILLIMETERS			
Dim	Min	Nom	Max	
Α	-	-	1.20	
A <sub>1</sub>	0.05	0.10	0.15	
A <sub>2</sub>	0.80	1.00	1.05	
В	0.19	0.28	0.30	
С	-	0.127	-	
D	2.90	3.00	3.10	
E	6.20	6.40	6.60	
E <sub>1</sub>	4.30	4.40	4.50	
е	-	0.65	-	
L	0.45	0.60	0.75	
L <sub>1</sub>	0.90	1.00	1.10	
Υ	-	-	0.10	
£ <b>K1</b>	0°	3°	6°	
ECN: S-03946—Rev. G, 09-Jul-01 DWG: 5844				

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## **RECOMMENDED MINIMUM PADS FOR TSSOP-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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